# High Speed 8-Bit A/D Converter with Built-In Sample-and-Hold 

## features

- Built-In Sample-and-Hold
- No Missing Codes
- No User Trims Required
- All Timing Inputs Edge Sensitive for Easy Processor Interface
- Fast Conversion Time: $2.5 \mu \mathrm{~s}$
- Latched Three-State Outputs
- Single 5V Operation
- No External Clock
- Overflow Output Allows Cascading
- TC Input Allows User Adjustable Conversion Time
- 0.3" Wide 20-Pin PDIP


## KEY SPECIFICATIONS

- Resolution: 8-Bits
- Conversion Time: 2.5 L (RD Mode) $2.5 \mu \mathrm{~S}$ (WR/RD Mode)
- Slew Rate Limit (Internal S/H): 2.5V/ $\mu \mathrm{S}$

Low Power: 75mW Max

- Total Unadjusted Error

LTC1099: $\pm 1$ LSB
LTC1099A: $\pm 0.75$ LSB

## DESCRIPTION

The LTC ${ }^{\circledR} 1099$ is a high speed microprocessor compatible 8-bit analog-to-digital converter (A/D). An internal sample-and-hold (S/H) allows the A/D to convert inputs up to the full Nyquist limit. With a conversion rate of $2.5 \mu \mathrm{~s}$, this allows $156 \mathrm{kHz} 5 \mathrm{~V}_{\text {P-p }}$ input signals or slew rates as high as $2.5 \mathrm{~V} / \mu \mathrm{s}$, to be digitized without the need for an external S/H.

Two modes of operation, Read (RD) mode and Write-Read (WR-RD) mode, allow easy interface with processors. All timing is internal and edge sensitive which eliminates the need for external pulse shaping circuits. The Stand-Alone (SA) mode is convenient for those applications not involving a processor

Data outputs are latched with three-state control to allow easy interface to a processor data bus or I/O port. An overflow output (OFL) is provided to allow cascading for higher resolution.

## TYPICAL APPLICATION



Signal-to-Noise Ratio (SNR) vs Input Frequency


## ABSOLUTE MAXIMUM RATINGS (Noles 1,2 )




Consult factory for parts specified with wider operating temperature ranges.
COOVEßTER CHARACTERISTICS The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{REF}^{+}=5 \mathrm{~V}$, $\mathrm{REF}^{-}=0 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {mis }}$ to $\mathrm{T}_{\text {max }}$ unless otherwise noted.

| PARAMETER | CONDITIONS |  | LTC1099AI/LTC1099 |  |  | LTC1099AC/LTC1099C |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| Accuracy |  |  |  |  |  |  |  |  |  |
| $\begin{aligned} & \text { Total Unadjusted Error } \\ & \text { LTC1099A } \\ & \text { LTC1099 } \end{aligned}$ | (Note 3) | $\bullet$ |  |  | $\begin{gathered} \pm 0.75 \\ \pm 1 \end{gathered}$ |  |  | $\begin{gathered} \pm 0.75 \\ \pm 1 \end{gathered}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \end{aligned}$ |
| Minimum Resolution (No Missing Codes) |  | $\bullet$ | 8 |  |  | 8 |  |  | Bits |
| Reference Input |  |  |  |  |  |  |  |  |  |
| Input Resistance |  | $\bullet$ | 1 | 3.2 | 6 | 2 | 3.2 | 4.5 | k $\Omega$ |
| REF+ Input Voltage Range | (Note 4) | $\bullet$ | REF- |  | $\mathrm{V}_{\text {CC }}$ | REF ${ }^{-}$ |  | $\mathrm{V}_{C C}$ | V |
| REF- Input Voltage Range | (Note 4) | $\bullet$ | GND |  | $\mathrm{REF}^{+}$ | GND |  | REF+ | V |
| Analog Input |  |  |  |  |  |  |  |  |  |
| Input Voltage Range |  | - | GND |  | $V_{C C}$ | GND |  | $V_{C C}$ | V |
| Input Leakage Current | $\overline{\mathrm{CS}}=\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {CC }}, \mathrm{GND}$ | $\bullet$ |  |  | $\pm 3$ |  |  | $\pm 3$ | $\mu \mathrm{A}$ |
| Input Capacitance |  |  |  | 60 |  |  | 60 |  | pF |
| Sample-and-Hold |  |  |  |  |  |  |  |  |  |
| Acquisition Time |  |  |  | 240 |  |  | 240 |  | ns |
| Aperture Time |  |  |  | 110 |  |  | 110 |  | ns |
| Tracking Rate |  |  |  | 2.5 |  |  | 2.5 |  | V/us |

## DIGITAL AOD DC ELECTRICAL CHARACTGRISTICS

The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{REF}^{+}=5 \mathrm{~V}, \mathrm{REF}^{-}=0 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ unless otherwise noted.

| SYMBOL | PARAMETER | CONDITIONS |  | LTC1099AI/LTC1099 |  |  | LTC1099AC/LTC1099C |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| $\mathrm{V}_{\text {IH }}$ | High Level Input Voltage | All Digital Inputs, $\mathrm{V}_{\text {CC }}=5.25 \mathrm{~V}$ | $\bullet$ | 2.0 |  |  | 2.0 |  |  | V |
| VIL | Low Level Input Voltage | All Digital Inputs, $\mathrm{V}_{\text {CC }}=4.75 \mathrm{~V}$ | $\bullet$ |  |  | 0.8 |  | 0.0001 | 0.8 | V |
| IIH | High Level Input Current | $\begin{aligned} & \mathrm{V}_{\mathbb{I H}}=5 \mathrm{~V} ; \overline{\mathrm{CS}}, \overline{\mathrm{RD}}, \text { Mode } \\ & \mathrm{V}_{I H}=5 \mathrm{~V} ; \overline{\mathrm{WR}} \end{aligned}$ | $\bullet$ |  | $\begin{aligned} & 0.0001 \\ & 0.0005 \end{aligned}$ | $\begin{aligned} & 1 \\ & 3 \end{aligned}$ |  | 0.0005 | $\begin{aligned} & 1 \\ & 3 \end{aligned}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| $\mathrm{l}_{\text {IL }}$ | Low Level Input Current | $\mathrm{V}_{\text {IL }}=0 \mathrm{~V}$; All Digital Inputs | $\bullet$ |  | -0.0001 | -1 |  | -0.0001 | -1 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\mathrm{OH}}$ | High Level Output Voltage | $\begin{aligned} & \text { DBO-DB7, } \overline{\mathrm{OFL}}, \overline{\mathrm{INT}} ; \mathrm{V}_{\text {CC }}=4.75 \mathrm{~V} \\ & \mathrm{I}_{\text {OUT }}=360 \mu \mathrm{~A} \\ & \mathrm{I}_{\text {OUT }}=10 \mu \mathrm{~A} \end{aligned}$ | $\bullet$ | 2.4 | $\begin{aligned} & 4.0 \\ & 4.7 \end{aligned}$ |  | 2.4 | $\begin{aligned} & 4.0 \\ & 4.7 \end{aligned}$ |  | V |
| $\mathrm{V}_{0 \mathrm{~L}}$ | Low Level Output Voltage | $\begin{aligned} & \text { DBO-DB7, } \overline{\mathrm{OFL}}, \overline{\mathrm{NT}}, \mathrm{RDY} ; \mathrm{V}_{\mathrm{CC}}=4.75 \mathrm{~V} \\ & \mathrm{I}_{\text {OUT }}=1.6 \mathrm{~mA} \end{aligned}$ | $\bigcirc$ |  |  | 0.4 |  |  | 0.4 | V |
| $l_{0 Z}$ | Hi-Z Output Leakage | $\begin{array}{\|l\|} \hline \text { DBO-DB7, RDY; } V_{\text {OUT }}=5 \mathrm{~V} \\ \text { DBO-DB7, RDY; } V_{\text {OUT }}=0 \mathrm{~V} \\ \hline \end{array}$ | $\bullet$ |  | $\begin{gathered} \hline 0.1 \\ -0.1 \\ \hline \end{gathered}$ | $\begin{gathered} 3 \\ -3 \end{gathered}$ |  | $\begin{gathered} \hline 0.1 \\ -0.1 \\ \hline \end{gathered}$ | $\begin{gathered} \hline 3 \\ -3 \end{gathered}$ | $\mu \mathrm{A}$ $\mu \mathrm{A}$ |
| $I_{\text {SOURCE }}$ | Output Source Current | DB0-DB7, $\overline{\text { OFL, }}$, INT; $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ | $\bullet$ |  | -11 | -6 |  | -11 | -7 | mA |
| ISINK | Output Sink Current | DB0-DB7, $\overline{\text { OFL }}$, İNT, RDY; $\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ | $\bullet$ |  | 14 | 7 |  | 14 | 9 | mA |
| ICC | Supply Current | $\overline{\mathrm{CS}}=\overline{\mathrm{WR}}=\overline{\mathrm{RD}}=\mathrm{V}_{\text {CC }}$ | $\bullet$ |  | 11 | 20 |  | 11 | 15 | mA |

AC CHARACTERISTICS The • denotes the specifications which apply over the full operating temperature range,
otherwise specifications are at $\mathrm{T}_{A}=25^{\circ} \mathrm{C}$. $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{REF}^{+}=5 \mathrm{~V}, \mathrm{REF}^{-}=0 \mathrm{~V}$ and $\mathrm{T}_{A}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$ unless otherwise noted.

| SYMBOL | PARAMETER | CONDITIONS |  | LTC1099AI/LTC1099I |  |  | LTC1099AC/LTC1099C |  |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | MIN | TYP | MAX | MIN | TYP | MAX |  |
| RD Mode (Figure 2) Pin 7 = GND |  |  |  |  |  |  |  |  |  |  |
| ${ }^{\text {CRD }}$ | Conversion Time | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\bullet$ | 2.2 | 2.5 | $\begin{aligned} & 2.8 \\ & 5.0 \end{aligned}$ | 2.2 | 2.5 | $\begin{gathered} \hline 2.8 \\ 3.75 \end{gathered}$ | $\begin{aligned} & \mu \mathrm{S} \\ & \mu \mathrm{~S} \end{aligned}$ |
| $\mathrm{t}_{\mathrm{RDY}}$ | Delay From $\overline{\mathrm{CS}} \downarrow$ to RDY $\downarrow$ | $C_{L}=100 \mathrm{pF}$ |  |  | 70 |  |  | 70 |  | ns |
| ${ }^{\mathrm{t}_{\text {ACCO }}}$ | Delay From $\overline{\mathrm{RD}} \downarrow$ to Output Data Valid | $C_{L}=100 \mathrm{pF}$ |  |  | $\mathrm{t}_{\text {CRD }}+35$ |  |  | $\mathrm{t}_{\text {CRD }}+35$ |  | ns |
| $\mathrm{t}_{\text {INTH }}$ | Delay From $\overline{\mathrm{RD}} \uparrow$ to $\overline{\mathrm{INT}} \uparrow$ | $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |  |  | 70 |  |  | 70 |  | ns |
| $\mathrm{t}_{1 \mathrm{H},} \mathrm{t}_{\mathrm{OH}}$ | Delay From $\overline{\mathrm{RD}} \uparrow$ to Hi-Z State on Outputs | Test Circuit Figure 1 |  |  | 70 |  |  | 70 |  | ns |
| tp | Delay Time Between Conversions |  |  |  | 700 |  |  | 700 |  | ns |
| $\mathrm{t}_{\text {ACC2 }}$ | Delay Time From $\overline{\mathrm{RD}} \downarrow$ to Output Data Valid |  |  |  | 70 |  |  | 70 |  | ns |
| WR/RD Mode (Figures 3 and 4) Pin $7=V_{\text {CC }}$ |  |  |  |  |  |  |  |  |  |  |
| $\mathrm{t}_{\text {cWR }}$ | Conversion Time | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\bullet$ | 2.2 | 2.5 | $\begin{aligned} & 2.8 \\ & 5.0 \end{aligned}$ | 2.2 | 2.5 | $\begin{gathered} \hline 2.8 \\ 3.75 \end{gathered}$ | $\begin{aligned} & \mu \mathrm{S} \\ & \mu \mathrm{~S} \end{aligned}$ |
| $\mathrm{t}_{\text {ACCO }}$ | Delay Time From $\overline{W R} \downarrow$ to Output Data Valid | $C_{L}=100 \mathrm{pF}$ |  |  | $t_{\text {cWR }}+40$ |  |  | $\mathrm{t}_{\text {cWR }}+40$ |  | ns |
| ${ }^{t_{\text {ACC2 }}}$ | Delay From $\overline{\mathrm{RD}} \downarrow$ to Output Data Valid | $C_{L}=100 \mathrm{pF}$ |  |  | 70 |  |  | 70 |  | ns |
| $\mathrm{t}_{\text {INTH }}$ | Delay From $\overline{\mathrm{RD}} \uparrow$ to $\overline{\mathrm{INT}} \uparrow$ | $C_{L}=100 \mathrm{pF}$ |  |  | 70 |  |  | 70 |  | ns |
| $\mathrm{t}_{\text {IHWR }}$ | Delay From $\overline{\mathrm{WR}} \downarrow$ to $\overline{\mathrm{INT}} \uparrow$ | $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$ |  |  | 240 |  |  | 240 |  | ns |
| $\mathrm{t}_{\underline{\text { H, }}, \mathrm{t}_{\mathrm{OH}}}$ | Delay From $\overline{\mathrm{RD}} \uparrow$ to Hi-Z State on Outputs | Test Circuit Figure 1 |  |  | 70 |  |  | 70 |  | ns |
| $t_{p}$ | Delay Time Between Conversions |  |  |  | 700 |  |  | 700 |  | ns |
| $\mathrm{t}_{\text {WR }}$ | Minimum $\overline{\text { WR }}$ Pulse Width |  |  |  | 55 |  |  | 55 |  | ns |

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.
Note 2: All voltages are with respect to GND (Pin 10) unless otherwise noted.

Note 3: Total unadjusted error includes offset, gain, linearity and hold step errors.
Note 4: Reference input voltage range is guaranteed but is not tested.

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## TYPICAL PERFORMANCE CHARACTERISTICS



Signal-to-Noise Ratio (SNR) vs Input Frequency


## PIn functions

$V_{\text {IN }}$ (Pin 1): Analog Input.
DBO to DB3 (Pins 2 to 5): Data Outputs. DB0 = LSB.
$\overline{W R} / R D Y$ (Pin 6): $\overline{W R} / R D Y$ is an input when MODE $=V_{C C}$. Falling edge of $\overline{W R}$ switches internal $\mathrm{S} / \mathrm{H}$ to hold then starts conversion. $\overline{W R} / R D Y$ is an open drain output (active pull-down) when MODE = GND. RDY goes low at start of conversion and pull-down is turned off when conversion is complete. Resistive pull-up is usually used in this mode.
MODE (Pin 7): WR-RD when MODE $=V_{C C}$. RD when MODE = GND. No internal pull-down.
$\overline{\mathrm{RD}}$ (Pin 8): A Low on $\overline{\mathrm{RD}}$ with $\overline{\mathrm{CS}}$ Low Activates ThreeState Outputs. With MODE = GND and $\overline{C S}$ low, the falling edge of $\overline{\mathrm{RD}}$ switches internal $\mathrm{S} / \mathrm{H}$ to hold and starts conversion.

INT (Pin 9): Output that goes low when the conversion in process is complete and goes high after data is read.
GND (Pin 10): Ground Connection.
REF ${ }^{-}$(Pin 11): Low Reference Potential (Analog Ground).
REF ${ }^{+}$(Pin 12): High Reference Potential. $\mathrm{V}_{\text {REF }}=$ Full Scale $=\left(\mathrm{REF}^{+}\right)-\left(\mathrm{REF}^{-}\right)$.
$\overline{\mathrm{CS}}$ (Pin 13): Chip Select. When high, data outputs are high impedance and all inputs are ignored.
DB4 to DB7 (Pins 14 to 17): Data Outputs. DB7 = MSB.
$\overline{\text { OFL }}$ (Pin 18): Overflow Output. Goes low when $\mathrm{V}_{\text {IN }}>\mathrm{V}_{\text {REF }}$.
$\mathrm{T}_{\mathrm{C}}$ (Pin 19): User Adjustable Conversion Time.
$\mathrm{V}_{\text {CC }}$ (Pin 20): Positive Supply. $4.75 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CC}} \leq 5.25 \mathrm{~V}$.

## TEST CIRCUITS



Figure 1. Three-State Test Circuit

## LTC1099

timing diagrams


Figure 2. RD Mode (Pin 7 Is GND)


Figure 3a. WR-RD Mode (Pin 7 Is HIGH and $\mathrm{t}_{\text {RD }}>\mathrm{t}_{\mathrm{CWR}}$ )


Figure 3b. WR-RD Mode (Pin 7 Is HIGH and $\mathrm{t}_{\mathrm{RD}}<\mathrm{t}_{\mathrm{CWR}}$ )


Figure 4. WR-RD Mode (Pin 7 Is HIGH) Standalone Operation

## FUNCTIOחAL DESCRIPTION

Figure 5 shows the functional block diagram for the LTC1099 2-step flash ADC. It consists of two 4-bit flash converters, a 4-bit DAC and a differencing circuit. The conversion process proceeds as follows:

1. At the start of the conversion, the on-board sample-and-hold switches from the sample to the hold mode. This is a true sample-and-hold with an acquisition time of 240 ns , an aperture time of 110 ns and a tracking rate of $2.5 \mathrm{~V} / \mu \mathrm{s}$.
2. The held input voltage is converted by the 4-bit MSFlash ADC. This generates the upper or most significant 4-bits of the 8-bit output.
3. A 4-bit approximation, from the DAC output, is subtracted from the held input voltage.
4. The LS-Flash ADC converts the difference between the held input voltage and the DAC approximation. This generates the lower or least significant (LS) 4-bits of the 8 -bit output. The LS-Flash reference is one sixteenth of the MS-Flash reference. This effectively multiplies the difference by 16.
5. Upon the completion of the LS 4-bit flash the eight output latches are updated simultaneously. At the same time, the sample-and-hold is switched from the hold mode to the acquire mode in preparation for the next conversion.

The advantage of this approach is the reduction in the amount of hardware required. A full flash converter requires 255 comparators while this approach requires only 31. The price paid for this reduction in hardware is an increase in conversion time. A full flash converter requires only one comparison cycle while this approach requires two comparison cycles, hence 2-step flash.

This architecture is further simplified in the LTC1099 by reusing the MS-Flash hardware to do the LS-Flash. This reduces the number of comparators from 31 to 16. This is possible because the MS and LS conversions are done at different times.

To take the simple block diagram of Figure 5 and reconfigure it to reuse the MS-Flash to do the LS-Flash is conceptually simple, but from a hardware point of view is not practical. A new six input switched capacitor comparator is used to


Figure 5. 8-Bit 2-Step Semiflash A/D
accomplish this function in a simple, although not straight forward, manner.
Figure 6 shows the six input switched capacitor comparator. Intuitively, the comparator is easy to understand by noting that the common connection between the two input capacitors, C1 and C2, acts like a virtual ground. In operational amplifier circuits, current is summed at the virtual ground node. Input voltage is converted to current by the input resistors. In the switched capacitor comparator, input voltage is converted to charge by the input capacitors and these charges are summed at the virtual ground node.
A major advantage of this technique is that the switch-on impedance has no affect on accuracy as long as sufficient time exists to fully charge and discharge the capacitors.

During the first time period the $T+$ and $T_{Z}$ switches are closed. This forces the common node between C1 and C2 to an arbitrary bias voltage. Since the capacitors subtract out this voltage, it may be considered, for the sake of this discussion, to be exactly zero (i.e., virtual ground). Note

## LTC 1099

## fUNCTIONAL DESCRIPTION



Figure 6. Six Input Switched Capacitor Comparator
also that variations in the bias voltage with time and temperature will also be rejected. In this state, C1 charges to $\mathrm{V}_{\text {IN }}$. When $\mathrm{T}_{\mathrm{Z}}$ opens, $\mathrm{V}_{\text {IN }}$ is held on C 1 .
The next step is the first comparison - the MS-Flash. $\mathrm{T}_{2}$ and $T+$ are opened and $T_{-1}$ is closed. The equation for each comparator is:

$$
\mathrm{V}_{I N}+0.5 \mathrm{LSB}-\mathrm{MS}_{\mathrm{TAP}}=0 \mathrm{~V}
$$

There are 16 identical comparators each tied to the tap on a 16 resistor ladder. The MS tap voltages vary from $\mathrm{V}_{\text {REF }}$ to OV in 16 equal steps of $\mathrm{V}_{\text {REF/ }} / 16$.
Notice that capacitor C2 adds 0.5 LSB to $\mathrm{V}_{\text {IN }}$. This offsets the converter transfer function by 0.5 LSB , equally distributing the 1 LSB quantization error to $\pm 0.5 \mathrm{LSB}$.
The outputs of the 16 comparators are temporarily latched and drive the 4-bit DAC directly without need of decoding.

This holds the DAC output constant for the next step - the LS conversion. The LS conversion is started when $\mathrm{T}_{-1}$ is opened and $\mathrm{T}_{-2}$ is closed. Capacitor C1 subtracts the 4-bit DAC approximation from $\mathrm{V}_{\mathrm{IN}}$ and inputs the difference charge to the virtual ground node. The equation for each comparator is:

$$
V_{I N}+0.5 L S B-V_{D A C}-L S_{T A P}=0 V
$$

The 4-bit DAC approximation is input to all 16 comparators. The LS tap voltages are converted to charge by capacitor C2. LS taps vary from $\mathrm{V}_{\text {REF }} / 16 \mathrm{~V}$ to 0 V in 16 equal steps of $V_{\text {REF }} / 256$. The comparators look at the net charge on the virtual ground node to perform the LS-Flash conversion. When this conversion is complete, the four LSBs along with the four MSBs are transferred to the output latches. In this way, all eight outputs will change simultaneously.

## DIGITAL InTERFACE

The digital interface to the LTC1099 entails either controlling the conversion timing or reading data. There are two basic modes for controlling and reading the $A / D$ - the Write-Read(WR-RD) mode and the Read (RD) mode.

## WR-RD Mode (Pin 7 = High)

In the WR-RD mode, a conversion sequence starts on the falling edge of $\overline{W R}$ with $\overline{\mathrm{CS}}$ low (Figures 3a and 3b). This is an edge-sensitive control function. The width of the $\overline{\mathrm{WR}}$ input is not important. All timing functions are internal to the $A / D$.

The first thing to happen after the falling edge of WR is the internal S/H is switched to hold. This typically takes 110 ns after $\overline{W R}$ falls and is the aperture time of the $S / H$.
Next, the A/D conversion takes place. The conversion time is internally set at $2.5 \mu \mathrm{~s}$, but is user adjustable (see Adjusting the Conversion Time). The end of conversion is signaled by the high to low transition of INT. The S/H is switched back to the acquire state as soon as the conversion is complete.

After the conversion is complete, the 8-bit result is available on the three-state outputs. The outputs are active with $\overline{\mathrm{RD}}$ and $\overline{\mathrm{CS}}$ low. Output data is latched and, if no new conversion is initiated, is available indefinitely as long as the power is not turned off.
The WR-RD mode is also used for stand-alone operation. By tying $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ low the data outputs will be continuously active (Figure 4). The falling edge of $\overline{W R}$ starts the conversion sequence and when done new data will appear on the outputs. All outputs will be updated simultaneously. In stand-alone operation, the outputs will never be in a high impedance state.

## RD Mode (Pin 7 = Low)

In the RD mode, a conversion sequence is initiated by the falling edge of $\overline{\mathrm{RD}}$ when $\overline{\mathrm{CS}}$ is low (Figure 2). The S/H is switched to the hold state 110ns after the falling edge of $\overline{\mathrm{RD}}$. It is switched back to the acquire state at the end of conversion.

When $\overline{\mathrm{RD}}$ goes low, with $\overline{\mathrm{CS}}$ low, the result of the previous conversion is output. This data stays there until the ongoing conversion is complete (INT goes low). At this time the outputs are updated with new data.
As long as $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ stay low long enough, the receiving device will get the right data. Remember, the receiving device reads data in on the rising edge of $\overline{\mathrm{RD}}$. The RDY output facilitates making RD long enough.
In the RD mode, the $\overline{W R}$ input becomes the RDY output. On the falling edge of $\overline{R D}$, the RDY goes low. It is an open drain output to allow a wired OR function so it requires a pull-up resistor. At the end of conversion, the active pulldown is released and RDY goes high.
The RDY output is designed to interface to the Ready In (RDYIN) function on many popular processors. RDYIN allows these processors to work with slow memory by stretching the $\overline{\mathrm{RD}}$ strobe coming from the processor. $\overline{\mathrm{RD}}$ will remain low as long as RDY is low. In the case of the LTC1099, RDY stays low until the conversion is complete and new data is available on the outputs. This greatly simplifies the programmers task. Each time data is required from the $A / D$ a simple read is executed. The hardware interface makes sure the $\overline{\mathrm{RD}}$ strobe is long enough.

## Adjusting the Conversion Time

The conversion time of the LTC1099 is internally set at $2.5 \mu \mathrm{~s}$. If desired, it can be adjusted by forcing a voltage on Pin 19. With Pin 19 left open, the conversion time runs $2.5 \mu \mathrm{~s}$. A convenient way to force the voltage is with the circuit shown in Figure 7. To preset the conversion time to a fixed amount, a resistor may be tied from Pin 19 to $V_{C C}$ or GND. Tying it to $\mathrm{V}_{\text {CC }}$ slows down the conversion and tying it to GND will speed it up (see Typical Performance Characteristics).


Figure 7. Adjusting the Conversion Time

## analog interface

The inclusion of a high quality sample-and-hold (S/H) simplifies the analog interface to the LTC1099. All of the error terms normally associated with an S/H (hold step, offset, gain and droop errors) are included in the error specifications for the A/D. This makes it easy for the designer since all the error terms need not be taken into account individually.

## S/H Timing

A falling edge on the $\overline{\mathrm{RD}}$ or $\overline{W R}$ input switches the $\mathrm{S} / \mathrm{H}$ from acquire to hold and starts the conversion. The aperture time is the delay from the falling edge to the actual instant when the S/H switches to hold. It is typically 110 ns .
As soon as a conversion is complete ( $2.5 \mu \mathrm{~s}$ typ), the $\mathrm{S} / \mathrm{H}$ switches back to the sample mode. Even though the acquisition time is only 240 ns , a new conversion cannot be started for (700ns typ) after a conversion is completed.

## Analog Input

The input to the A/D looks like a 60 pF capacitor in series with $550 \Omega$ (Figure 8).


Figure 8. Equivalent Input Circuit
With this high input capacitance care must be taken when driving the inputs from a source amplifier. When the input switch closes, an instantaneous capacitive load is applied to the amplifier output. This acts like an impulse into the amplifier and if it has poor phase margin the resulting ringing can cause a considerable loss of accuracy. If the amplifier is too slow the resulting settling tail will also cause a loss of accuracy. The amplifier should also have low open circuit output impedance. The LT1006 is an
excellent amplifier in this regard. It also works with a single supply which fits nicely with the LTC1099.

## Reference Inputs

Sixteen equal valued resistors are internally connected between REF $^{+}$and REF $^{-}$. Each resistor is nominally $200 \Omega$ giving a total resistance of 3.2 k between the reference terminals. When $\mathrm{V}_{\text {IN }}$ equals REF ${ }^{+}$, the output code will be all ones. When $\mathrm{V}_{\text {IN }}$ equals REF-, the output code will be all zeros.
Although it is most common to connect REF $^{+}$to a 5 V reference and REF- to ground, any voltages can be used. The only restrictions are $\mathrm{REF}^{+}>$REF $^{-}$and $\mathrm{REF}^{+}$and REF $^{-}$ must be within the supply rails. As the reference voltage is reduced the $A / D$ will eventually lose accuracy. Accuracy is quite good for references down to 1 V .

Even though the reference drives a resistive ladder, a lot of capacitive switching is taking place internally. For this reason, driving the reference has the same characteristics as driving $\mathrm{V}_{\mathbf{I N}}$. A fast low impedance source is necessary. The reference has the additional problem of presenting a DC load to the driving source. This requires the DC as well as the AC source impedance to be low.

## Good Grounding

As with any precise analog system care must be taken to follow good grounding practices when using the LTC1099. The most noise free environment is obtained by using a ground plane with GND (Pin 10) and REF ${ }^{-}$(Pin 11) tied to it. Bypass capacitors from REF ${ }^{+}$(Pin 12) and $V_{C C}$ (Pin 20) with short leads are also required to prevent spurious switching noise from affecting the conversion accuracy.
If a ground plane is not practical, single point grounding techniques should be used. Ground for the A/D should not be mixed in with other noisy grounds.
annlog interface

## APPLICATIONS

## Analog Multiplier

The schematic Figure 9 shows the LTC1099 configured with a DAC to form a two quadrant analog multiplier. An input waveform is applied to the LTC1099 where it is digitized at a 300 kHz rate. The digitized signal is fed to the DAC in "flow-through" mode where another signal is input to the DAC reference input. In this way, the two analog signals are multiplied to produce a double sideband amplitude modulated output. Figure 10 shows a 3 kHz sine wave multiplied by a 100 Hz triangle.

Note that since this is only a two quadrant multiplier, a carrier component (the input to the LTC1099) will appear in the output spectrum. Figure 11 shows the frequency spectrum of a 42.5 kHz sine wave multiplied by a 5 kHz sine wave. The depth of modulation is about 30dB. Figure 12 shows a 42.375 kHz sine wave multiplied by a 30.875 kHz sine wave. Note that at these higher frequencies, the depth of modulation is still about 30 dB . The carrier feed-through is seen in Figure 12.


Figure 9


Figure 10

AnALOG InTERFACE


Figure 11. Two Quadrant Multiplier Output Spectrum with OV to 4.5 V at 42.5 kHz into LTC1099 and $\pm 2 \mathrm{~V}$ at 5 kHz into DAC


Figure 12. Two Quadrant Multiplier Output Spectrum with OV to 4.5 V at 42.375 kHz into LTC1099 and $\pm 2 \mathrm{~V}$ at 30.875 kHz into DAC

## TYPICAL APPLICATIONS

TMS320C25 Interface Using RD Mode


TMS320C25 Assembly Code for RD Mode Interface to LTC1099

| 0001 | 0000 |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :--- |
| 0002 | 0032 |  |  | AORG | $>32$ |  |
| 0003 | 0032 | CE01 |  | DINT |  | Disable Interrupts |
| 0004 | 0033 | C800 |  | LDPK | $>00$ | Data Page Pointer Is 0 |
| 0005 | 0034 | 8064 | LOOP | IN | 100, PAO | Input 1099 Data to Address 100 |
| 0006 | 0035 | CB13 |  | RPTK | 12 | Repeat Next Instruction 12 Times |
| 0007 | 0036 | 5500 |  | NOP |  | Don't Convert Again Too Soon |
| 0008 | 0037 | FF80 |  | B | LOOP | Go for Another Conversion |

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## LTC 1099

## TYPICAL APPLICATIONS

TMS320C25 Interface Using WR/RD Mode


TMS320C25 Assembly Code for WR/RD Mode Interface to LTC1099

| 0001 | 0032 |  |  | AORG | $>32$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :--- |
| 0002 | 0032 | CE01 |  | DINT |  | Disable Interrupts |
| 0003 | 0033 | C800 |  | LDPK | $>0$ | Data Page Pointer Is 0 |
| 0004 | 0034 | E064 | LOOP | OUT | $>64$. PAO | Start LTC1099 Conversion |
| 0005 | 0035 | CB20 |  | RPTK | $>12$ | Wait for Conversion to Finish |
| 0006 | 0036 | 5500 |  | NOP |  |  |
| 0007 | 0037 | 8064 |  | IN | $>64$. PAO | Read LTC1099 Data; Store in >64 |
| 0008 | 0038 | FF80 |  | B | LOOP | Do Again |

# PACKAGE DESCRIPTION 

Dimensions in inches (millimeters) unless otherwise noted.
N Package
20-Lead PDIP (Narrow 0.300)
(LTC DWG \# 05-08-1510)

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH ( 0.254 mm )
N20 1098

SW Package
20-Lead Plastic Small Outline (Wide 0.300)
(LTC DWG \# 05-08-1620)


NOTE:

1. PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS.
THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS
*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006 " $(0.152 \mathrm{~mm})$ PER SIDE
**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED $0.010^{\prime \prime}(0.254 \mathrm{~mm})$ PER SIDE

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## TYPICAL APPLICATIONS

Cascading for 9-Bit Resolution


## RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :--- | :--- | :--- |
| LTC1274/LTC1277 | 12-Bit, 100ksps Parallel/2-Byte ADC | 5 V or $\pm 5 \mathrm{~V}, 10 \mathrm{~mW}$ with $1 \mu \mathrm{~A}$ Shutdown |
| LTC1279 | 12-Bit, 600ksps Parallel ADC | $5 \mathrm{~V}, 60 \mathrm{~mW}, 70 \mathrm{~dB}$ SINAD |
| LTC1406 | 8 -Bit, 20Msps Parallel ADC | $5 \mathrm{~V}, 150 \mathrm{~mW}, 48.5 \mathrm{~dB} \mathrm{SINAD}$ |
| LTC1409 | 12 -Bit, 800ksps Parallel ADC | $\pm 5 \mathrm{~V}, 80 \mathrm{~mW}, 72.5 \mathrm{~dB} \mathrm{SINAD}$ |
| LTC1419 | 14-Bit, 800ksps Parallel ADC | $\pm 5 \mathrm{~V}, 150 \mathrm{~mW}, 81.5 \mathrm{~dB}$ SINAD |

